

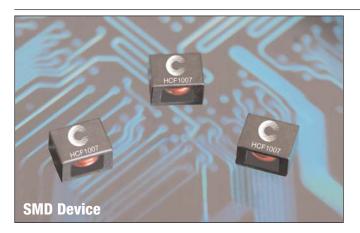
High Current, High Frequency, Power Inductors

HCF1007 Series









Description

- · Halogen free
- 125°C maximum total temperature operation
- 10.3 x 8.1 x 6.65mm surface mount package
- · Ferrite core material
- · Secure 3 terminal mounting
- High current carrying capacity, low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 0.3µH to 10.0µH
- Current range from 5.3 to 48 Amps
- Frequency range up to 1MHz
- RoHS compliant

Applications

- · Point-of-load modules
- Multi-phase regulators
- Voltage Regulator Module (VRM)
- Desktop and server VRMs and EVRDs
- Data networking and storage systems
- Notebook regulators
- Graphics cards and battery power systems
- DCR current sensing

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant

Packaging

• Supplied in tape and reel packaging, 700 parts per 13" diameter reel

		F	Product Sp	ecifications			
	OCL1	FLL ²	I _{rms} ³	I _{sat} 1 ⁴	I _{sat} 2 ⁵	DCR m Ω	
Part Number ⁷	μH ± 20%	Min (μH)	Amps	Amps @25°C	Amps @125°C	@20°C	K-factor ⁶
HCF1007-R30-R	0.30	0.21	30	48	35	0.90±10%	279.9
HCF1007-R42-R	0.42	0.30	26	45	36	1.30±7%	186.6
HCF1007-R56-R	0.56	0.40	26	36	28	1.30±7%	186.6
HCF1007-R68-R	0.68	0.49	26	29	23	1.30±7%	186.6
HCF1007-1R0-R	1.0	0.72	16	26	21	2.65±6%	139.9
HCF1007-1R5-R	1.5	1.08	13	22	17	4.15±6%	112.0
HCF1007-2R2-R	2.2	1.57	10.7	18	14	6.35±6%	93.30
HCF1007-3R3-R	3.3	2.37	10	14.5	11	7.50±6%	79.97
HCF1007-4R7-R	4.7	3.38	9.4	12	8.9	8.65±6%	69.97
HCF1007-5R6-R	5.6	4.03	9.4	9.4	7.5	8.65±6%	69.97
HCF1007-6R8-R	6.8	4.90	9.4	7.8	6.1	8.65±6%	69.97
HCF1007-100-R	10.0	7.20	9.4	5.3	4.2	8.65±6%	69.97

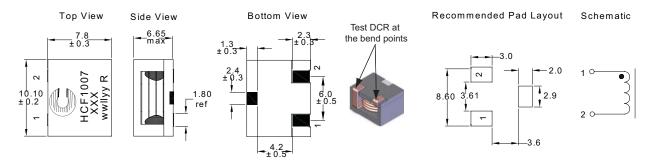
- 1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0Adc
- 2~ Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1V $_{rms},$ $\rm I_{sat}1$
- 3 $\,$ I $_{rms}$: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 4 I_{sat}1: Peak current for approximately 20% rolloff at +25°C.

- 5 I_{sat}2: Peak current for approximately 20% rolloff at +125°C.
- 6 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I$. B_{p-p} :(Gauss), K: (K-factor from table), L: (Inductance in μH), ΔI (peak-to-peak ripple current in amps).
- 7 Part Number Definition:HCF1007-xxx-R
 - HCF1007 = Product code and size
 - xxx= Inductance value in μH, R = decimal point. If no "R" is present then third character =# of zeros
 - -R suffix = RoHS compliant

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Dimensions - mm

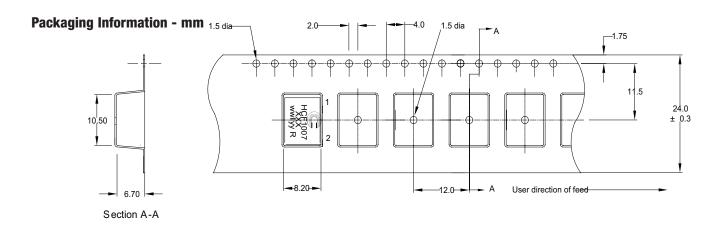


Part Marking: Coiltronics logo

HCF1007

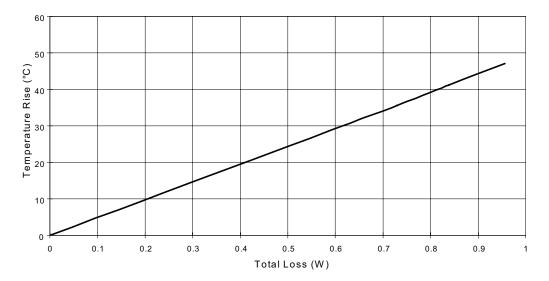
xxx =Inductance value in μ H. (R = Decimal point). If no "R" is present, then last character is # of zeros yyllww =Date code

R = Revision level



Supplied in tape-and-reel packaging, 700 parts per reel, 13" diameter reel.

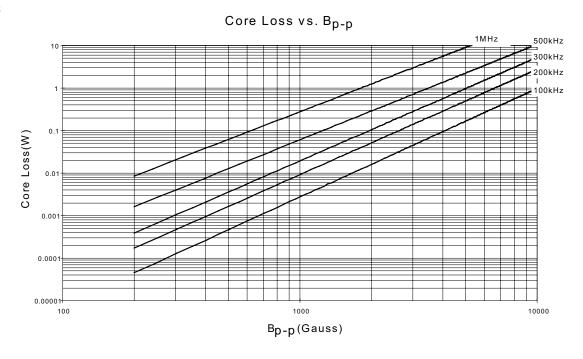
Temperature Rise vs. Total Loss



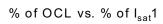
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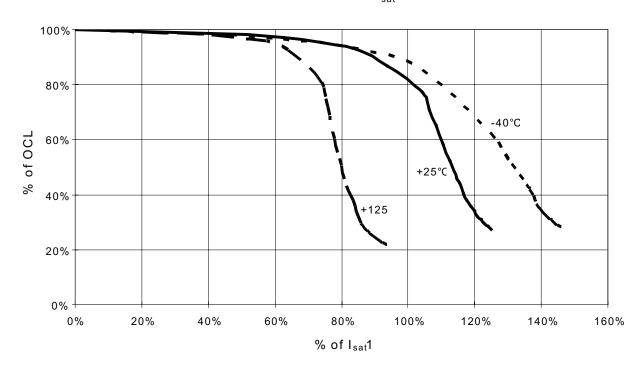


Core Loss



Inductance Characteristics





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Solder Reflow Profile

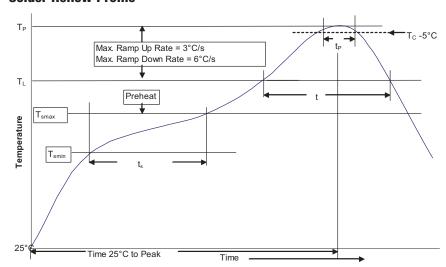


Table 1 - Standard SnPb Solder (T_c)

Package Thickness	Volume mm³ <350	Volume mm³ >350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package	Volume mm³	Volume mm³	Volume mm ³
Thickness	<350	350 - 2000	>2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

	0 0 1 2 0 2 0 2 0 2 0 2 0 2 0 2 0 2 0 2			
Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	• Temperature min. (T _{smin})	100°C	150°C	
	 Temperature max. (T_{smax}) 	150°C	200°C	
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{Smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)		183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body t	temperature (T _P)*	Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (t_n) is defined as a supplier minimum and a user maximum.

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